



YEA SHIN TECHNOLOGY CO., LTD

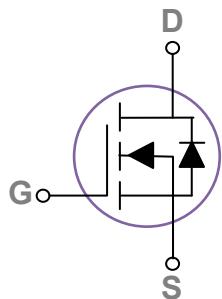
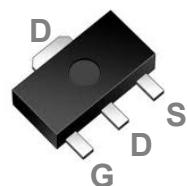
YS2314K

N-Channel Enhancement MOSFET

VDS= 20V, ID= 5.6A

Features

- 20V, 5.6A, $R_{DS(ON)} = 26m\Omega$ @ $V_{GS} = 4.5V$
- Improved dv/dt capability
- Fast switching
- Green Device Available
- Suit for 1.8V Gate Drive Applications

SOT-89 Pin Configuration**Applications**

- Notebook
- Load Switch
- Hand-Held Instruments

Absolute Maximum Rating $T_c=25^\circ C$ unless otherwise noted

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	20	V
V_{GS}	Gate-Source Voltage	± 10	V
I_D	Drain Current – Continuous ($T_c=25^\circ C$)	5.6	A
	Drain Current – Continuous ($T_c=100^\circ C$)	3.5	A
I_{DM}	Drain Current – Pulsed ¹	22.4	A
P_D	Power Dissipation ($T_c=25^\circ C$)	1.47	W
	Power Dissipation – Derate above 25°C	0.012	W/°C
T_{STG}	Storage Temperature Range	-55 to 150	°C
T_J	Operating Junction Temperature Range	-55 to 150	°C

Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction to ambient	---	85	°C /W

DEVICE CHARACTERISTICS

YS2314K

Electrical Characteristics ($T_J=25^\circ\text{C}$, unless otherwise)

Off Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$	20	---	---	V
$\Delta \text{BV}_{\text{DSS}}/\Delta T_J$	BV_{DSS} Temperature Coefficient	Reference to 25°C , $I_{\text{D}}=1\text{mA}$	---	0.02	---	$\text{V}/^\circ\text{C}$
I_{DSS}	Drain-Source Leakage Current	$V_{\text{DS}}=20\text{V}, V_{\text{GS}}=0\text{V}, T_J=25^\circ\text{C}$	---	---	1	μA
		$V_{\text{DS}}=16\text{V}, V_{\text{GS}}=0\text{V}, T_J=125^\circ\text{C}$	---	---	10	μA
I_{GSS}	Gate-Source Leakage Current	$V_{\text{GS}}=\pm 10\text{V}, V_{\text{DS}}=0\text{V}$	---	---	± 100	nA

On Characteristics

$R_{\text{DS(ON)}}$	Static Drain-source On-Resistance ²	$V_{\text{GS}}=4.5\text{ V}, I_{\text{D}}=4\text{A}$	---	22	26	$\text{m}\Omega$
		$V_{\text{GS}}=2.5\text{V}, I_{\text{D}}=3\text{A}$	---	28	36	$\text{m}\Omega$
		$V_{\text{GS}}=1.8\text{V}, I_{\text{D}}=2\text{A}$	---	39	51	$\text{m}\Omega$
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{GS}}=V_{\text{DS}}, I_{\text{D}}=250\mu\text{A}$	0.4	0.6	1	V
$\Delta V_{\text{GS(th)}}$	$V_{\text{GS(th)}}$ Temperature Coefficient		---	-2	---	$\text{mV}/^\circ\text{C}$
g_{fs}	Forward Transconductance	$V_{\text{DS}}=10\text{V}, I_{\text{D}}=3\text{A}$	---	7	---	S

Dynamic and Switching Characteristics

Q_g	Total Gate Charge ^{2,3}	$V_{\text{DS}}=10\text{V}, V_{\text{GS}}=4.5\text{V}, I_{\text{D}}=4\text{A}$	---	7.7	11	nC
Q_{gs}	Gate-Source Charge ^{2,3}		---	0.9	1	
Q_{gd}	Gate-Drain Charge ^{2,3}		---	2.4	5	
$T_{\text{d(on)}}$	Turn-On Delay Time ^{2,3}	$V_{\text{DD}}=10\text{V}, V_{\text{GS}}=4.5\text{V}, R_{\text{G}}=25\Omega, I_{\text{D}}=1\text{A}$	---	4.1	8	ns
T_r	Rise Time ^{2,3}		---	11.6	22	
$T_{\text{d(off)}}$	Turn-On Delay Time ^{2,3}		---	23.9	45	
T_f	Fall Time ^{2,3}		---	7.6	14	
C_{iss}	Input Capacitance		---	535	775	pF
C_{oss}	Output Capacitance	$V_{\text{DS}}=10\text{V}, V_{\text{GS}}=0\text{V}, f=1\text{MHz}$	---	60	85	
C_{rss}	Reverse Transfer Capacitance		---	34	50	

Drain-Source Diode Characteristics and Maximum Ratings

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I_s	Continuous Source Current	$V_G=V_D=0\text{V}$, Force Current	---	---	5.6	A
I_{SM}	Pulsed Source Current ²		---	---	22.4	A
V_{SD}	Diode Forward Voltage ²	$V_{\text{GS}}=0\text{V}, I_{\text{S}}=1\text{A}, T_J=25^\circ\text{C}$	---	---	1	V

Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. The data tested by pulsed , pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$.
3. Essentially independent of operating temperature.

DEVICE CHARACTERISTICS

YS2314K

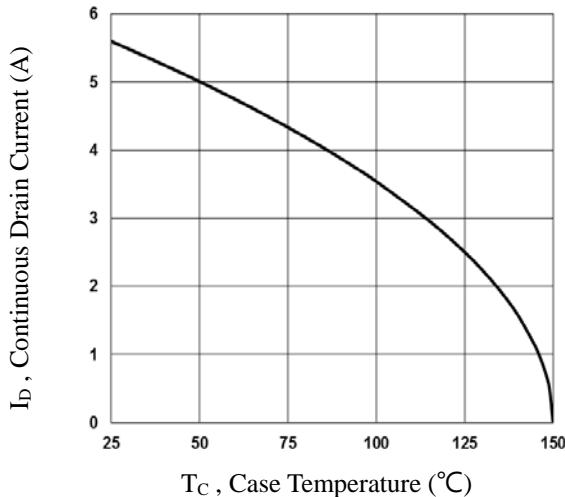


Fig.1 Continuous Drain Current vs. T_C

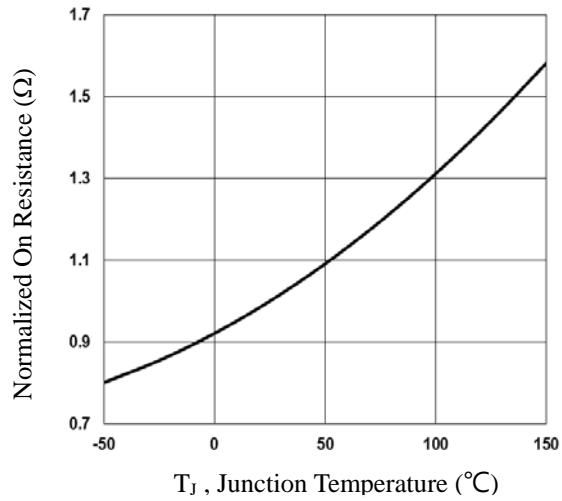


Fig.2 Normalized RDS_{ON} vs. T_J

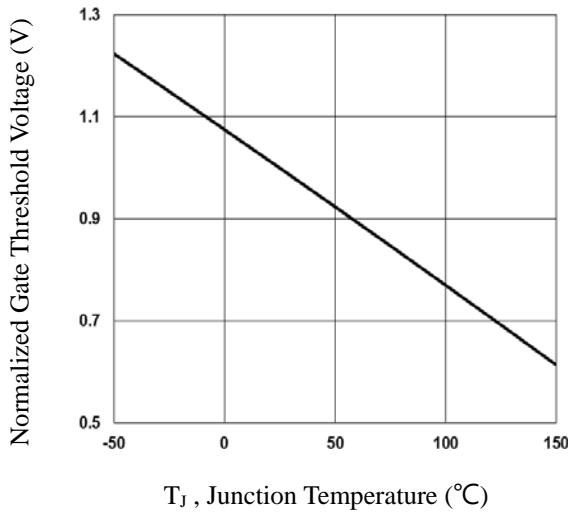


Fig.3 Normalized V_{th} vs. T_J

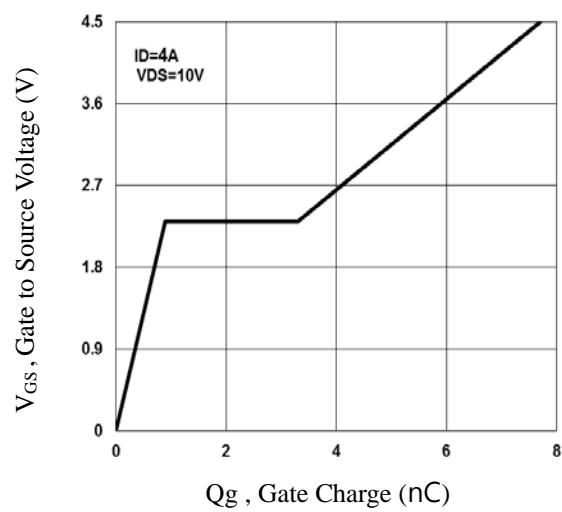


Fig.4 Gate Charge Waveform

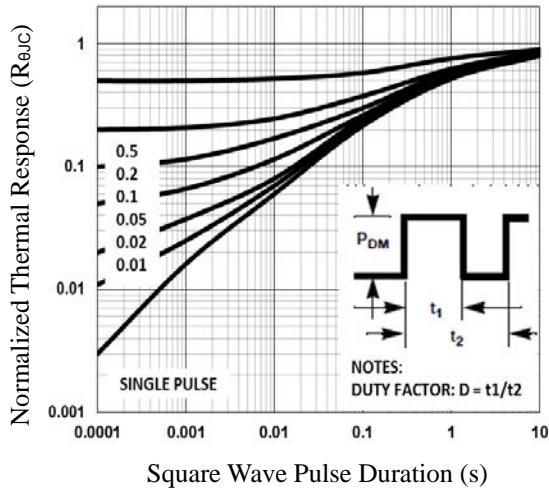


Fig.5 Normalized Transient Impedance

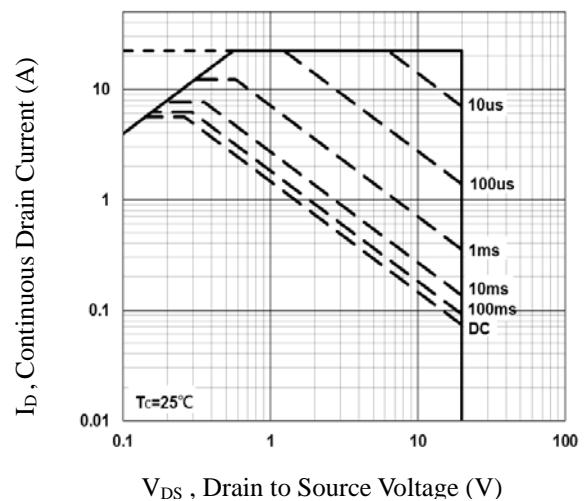


Fig.6 Maximum Safe Operation Area

DEVICE CHARACTERISTICS

YS2314K

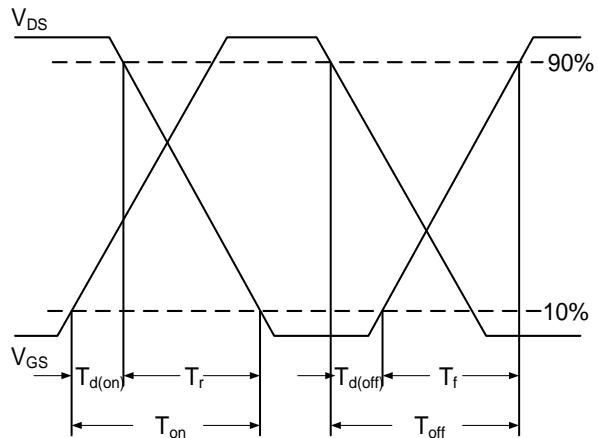


Fig.7 Switching Time Waveform

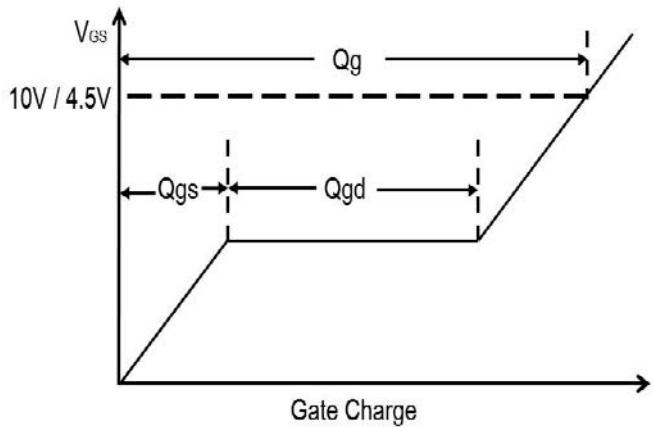
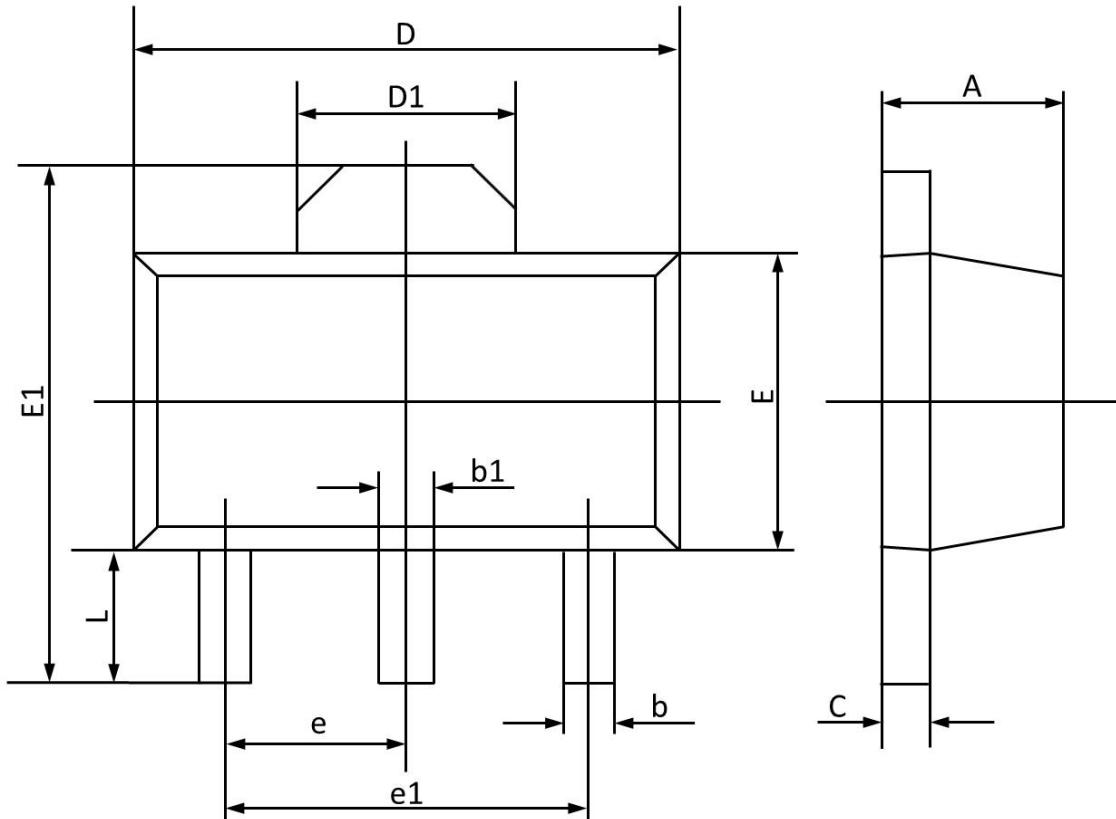


Fig.8 Gate Charge Waveform

PACKAGE OUTLINE & DIMENSIONS

YS2314K

SOT-89 PACKAGE INFORMATION



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.400	1.600	0.055	0.063
b	0.320	0.520	0.013	0.020
b1	0.400	0.580	0.016	0.023
c	0.350	0.440	0.014	0.017
D	4.400	4.600	0.173	0.181
D1	1.550 REF		0.061 REF	
E	2.300	2.600	0.091	0.102
E1	3.940	4.250	0.155	0.167
e	1.500 TYP.		0.060 TYP.	
e1	3.000 TYP		0.118 TYP	
L	0.900	1.200	0.035	0.047